

Characterization after neutron irradiation of Silicon Diodes for the CMS High Granularity Calorimeter (HGCAL)

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Outline

- ✓ High Granularity Calorimeter (HGICAL)
- ✓ HGICAL silicon sensors
- ✓ Results of the characterization after neutron irradiation
- ✓ Summary and future activities

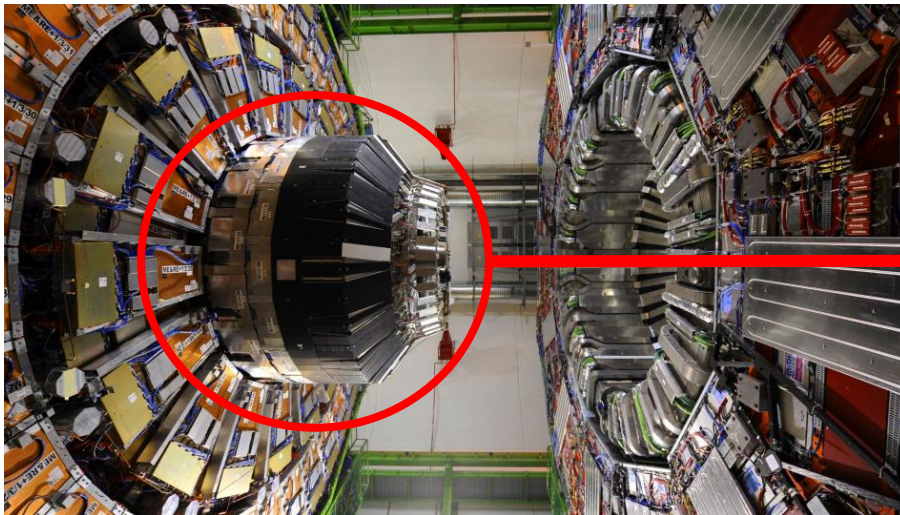
High Granularity Calorimeter (HGCAL)

CMS needs to replace End-cap Electromagnetic and Hadronic calorimeters for Phase II due to radiation damage. This opens new possibilities for Calorimeter design.

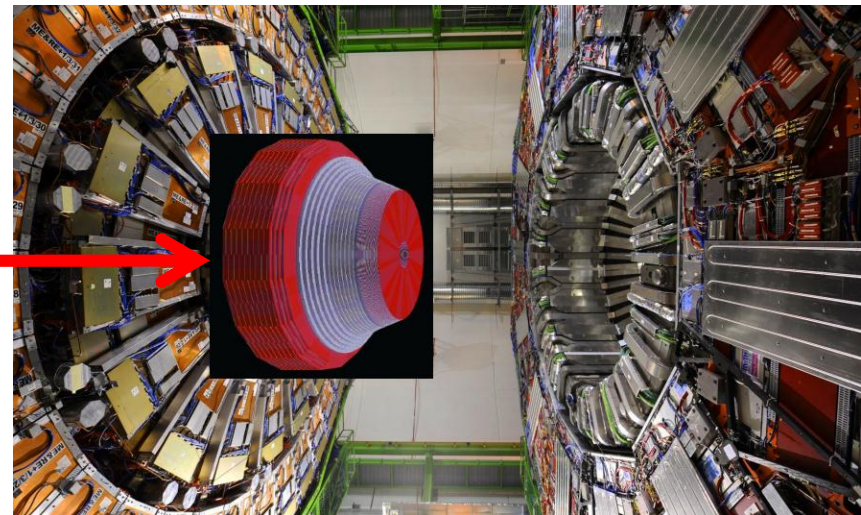
We are investigating in detail the possibility of using a high granularity calorimeter with $\sim 9\text{M}$ channels of silicon pads, integrating EE and HE functions (CALICE concept) with a Back HE to capture energy tails.

We expect that with such detailed information from the calorimeter, coupled with a precision silicon tracker, we will be able to measure physics objects with high precision.

Current detector



An Si Based HGC CMS at the HL-LHC



High Granularity Calorimeter (HGCAL)

Major Engineering Challenges

600 m² of Silicon in a high radiation environment.

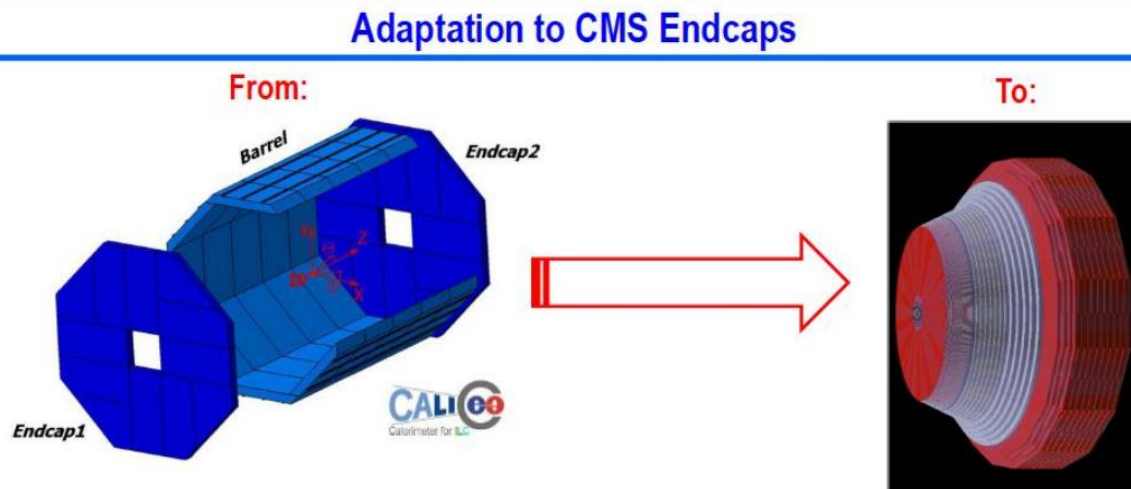
- ✓ Cost.
- ✓ Very high radiation levels – need to plan for 3×10^{16} neutrons/cm² in the highest

Cooling.

- ✓ We need a compact calorimeter with small gaps between absorber plates.
- ✓ We need to operate at -30°C
- ✓ Total power is ~ 100 kW.

Data and Trigger

- ✓ Channel count is 9M. Producing a prodigious amount of data.
- ✓ Data used in the Level- 1 CMS event trigger.



HGCAL Silicon sensors

Tolerance study of large area pad diodes as active sensor for a High Granularity Electromagnetic Endcap Calorimeter for Phase II Upgrade

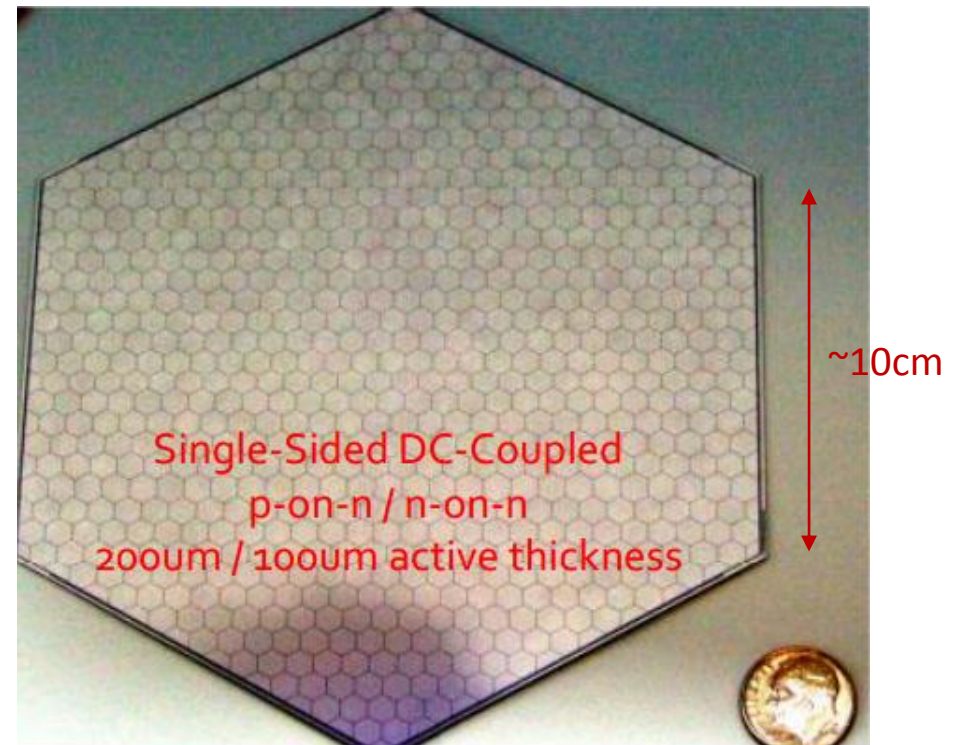
Investigate sensor performance after **neutron irradiation** with neutron equivalent fluences up to $1 \cdot 10^{16} \text{n/cm}^2$

Sensors under investigation:

- ✓ Silicon growth technique (Epi: epitaxial layer, FZ: floating zone)
- ✓ Polarity: n-on-p (p-type), p-on-n (n-type)
- ✓ Active thickness:
 - FZ: 320, 200 and 120 μm
 - Epi: 100 and 50 μm
- ✓ Size:
 - Large diodes : $5 \times 5 \text{ mm}^2$
 - Small diodes : $2 \times 2 \text{ mm}^2$

HGCAL operating conditions:

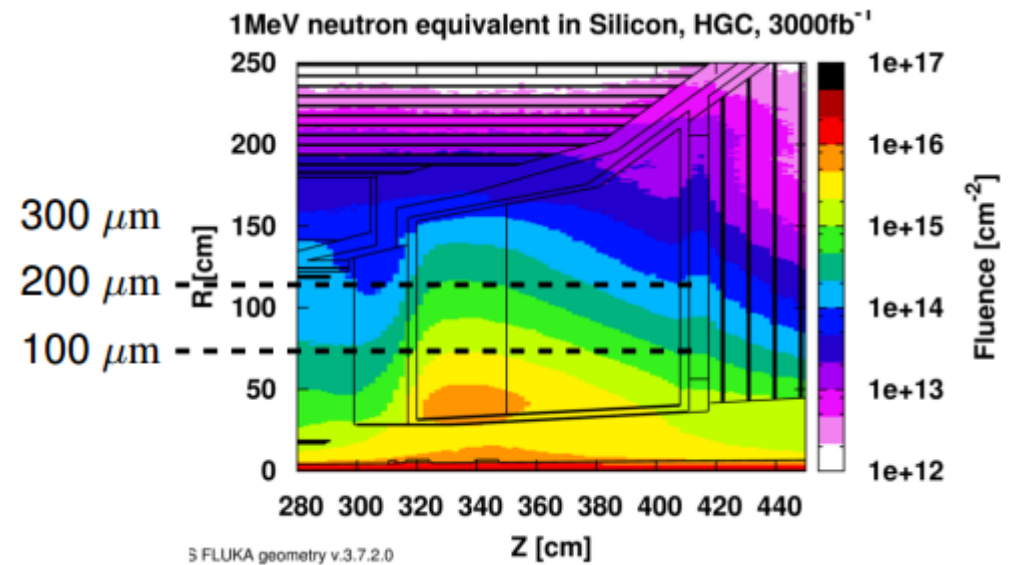
- ✓ Temperature (T) $< -30^\circ\text{C}$: $\sim -35^\circ\text{C}$
- ✓ Bias voltage (U): $600 \div 1000 \text{ V}$



HGCAL Silicon sensors

Available sensors

- ✓ Sensors irradiated in Ljubljana
- ✓ Sensors now at Hamburg University
- ✓ 2 identical sensors for each type and each fluence
- ✓ P: bulk P (n-on-p)
- ✓ N: bulk N (p-on-n)



List of sensors:

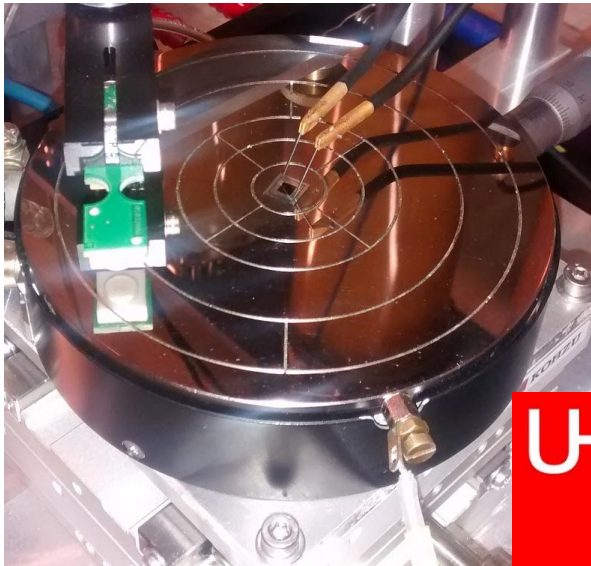
Fluence (Φ) [n/cm ⁻²]	Thickness [μ m]			
	320	200	120	50
4e14	2 FZ-P, 2 FZ-N			
→ 6e14	2 FZ-P, 2 FZ-N			
1.5e15		2 FZ-P, 2 FZ-N		
→ 2.5e15		2 FZ-P, 2 FZ-N		
6.25e15			2 FZ-P, 2 FZ-N, 1Epi-P	
→ 1.0e16			2 FZ-P, 2 FZ-N, 2Epi-P	2 Epi-P, 2Epi-N
1.6e16			2 FZ-P, 2 FZ-N	2 Epi-P, 2Epi-N

Characterization after neutron irradiation

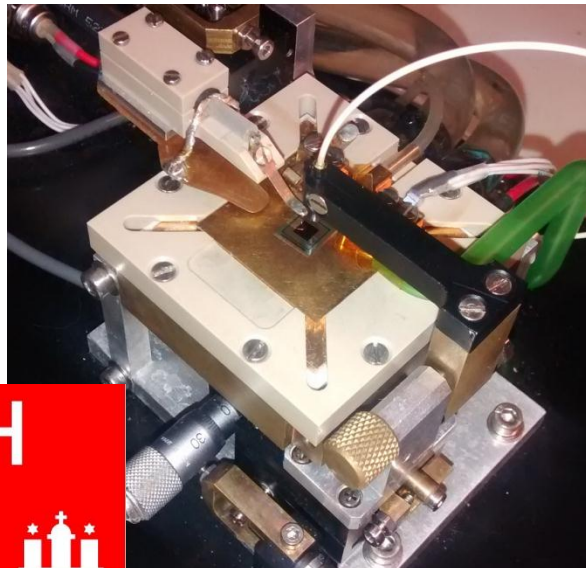
Properties to be measured:

- ✓ Bulk current $I(U, \Phi, h) \rightarrow$ power consumption, noise
- ✓ Capacitance (1 MHz signal): $C(U, \Phi, h) \rightarrow$ capacitance seen by electronics (below $\sim 50\text{pF}$)
- ✓ Charge collection efficiency $\text{CCE}(U, \Phi, \text{thickness}) \rightarrow$ signal
- ✓ MIP sensitivity with beta source \rightarrow for calibration purpose and S/N
- ✓ Effect of annealing on the properties (up to 3 months at room temperature)

IV/CV set-up



TCT set-up for CCE
IR laser (1063 nm)



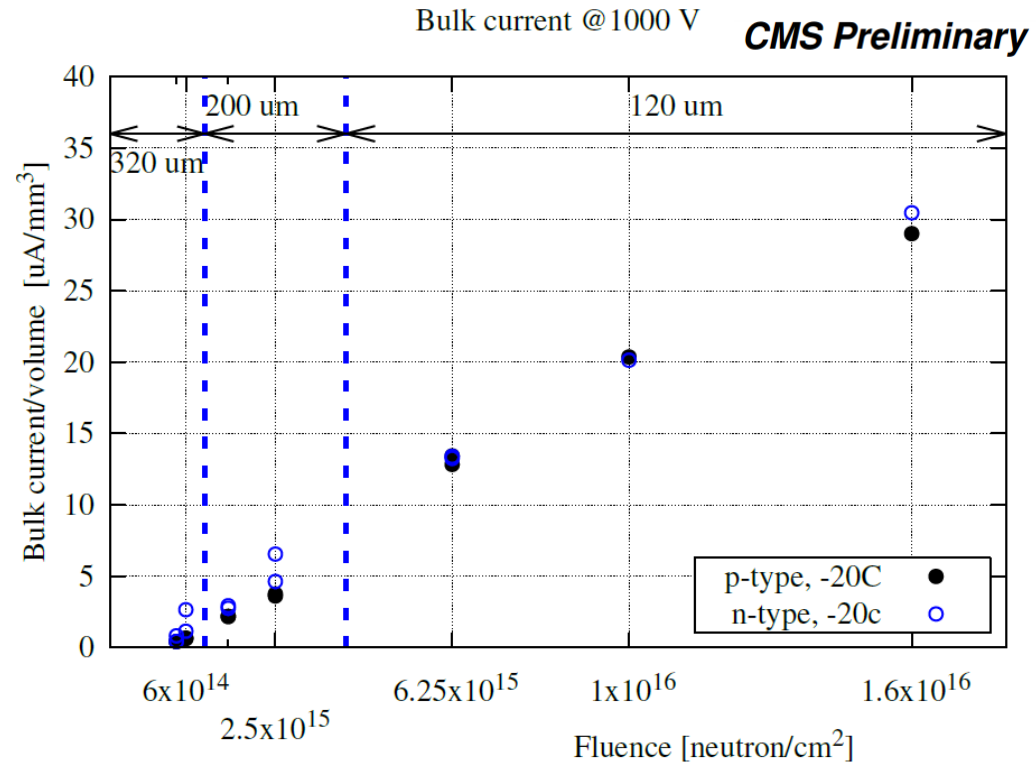
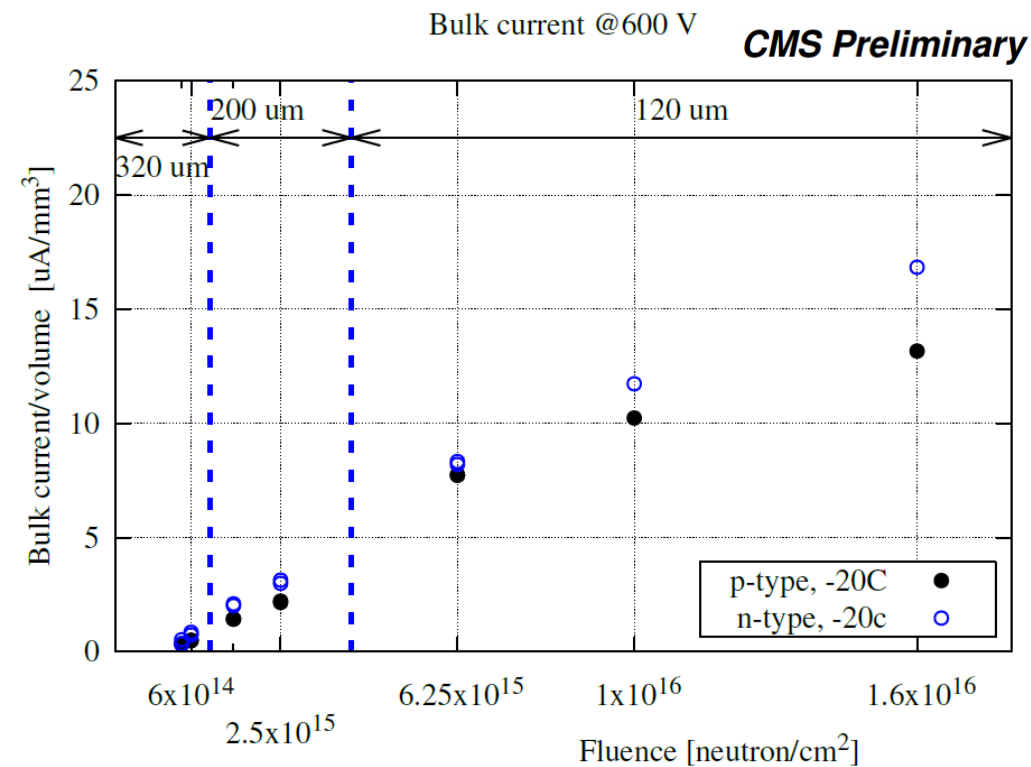
U: bias voltage (V)
 Φ : neutron fluence (cm^{-2})
T: operating temperature
h: sensor thickness (μm)

→ 
continue with
measures at CERN



Characterization after neutron irradiation

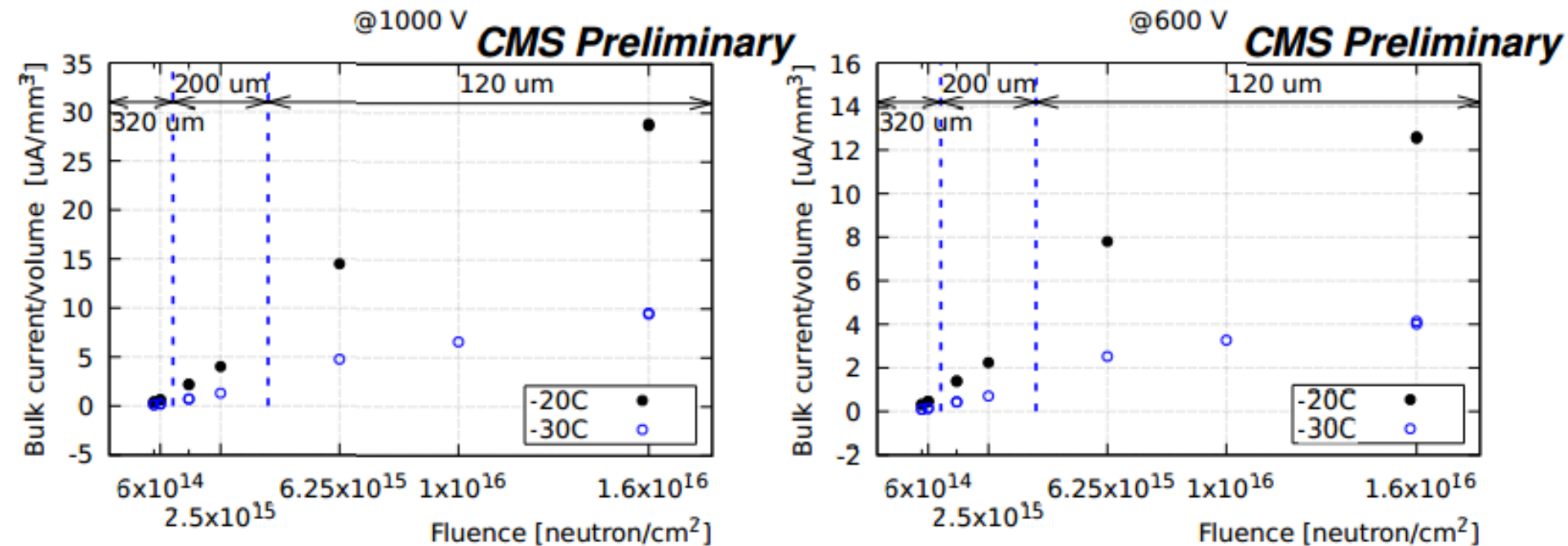
Bulk current vs fluence \Rightarrow N-type vs P-type diodes



- ✓ Bulk current normalized by the volume of the diode
- ✓ Bulk current compatible between P and N type diodes

Characterization after neutron irradiation

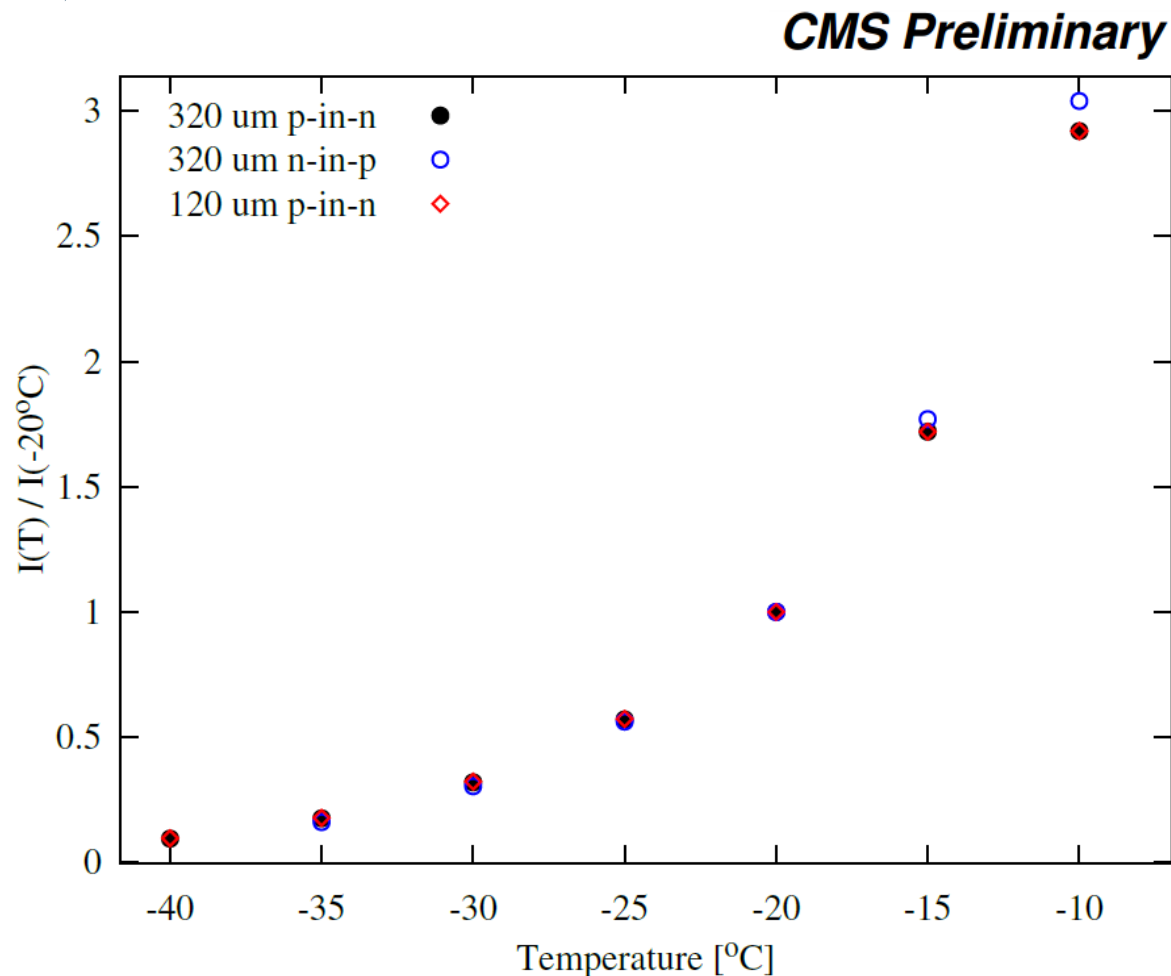
Bulk current vs fluence \Rightarrow Temperature dependence



- ✓ Bulk current normalized by the volume of the diode
- ✓ $I(-20^{\circ}\text{C}) \sim 3 \cdot I(-30^{\circ}\text{C})$

Characterization after neutron irradiation

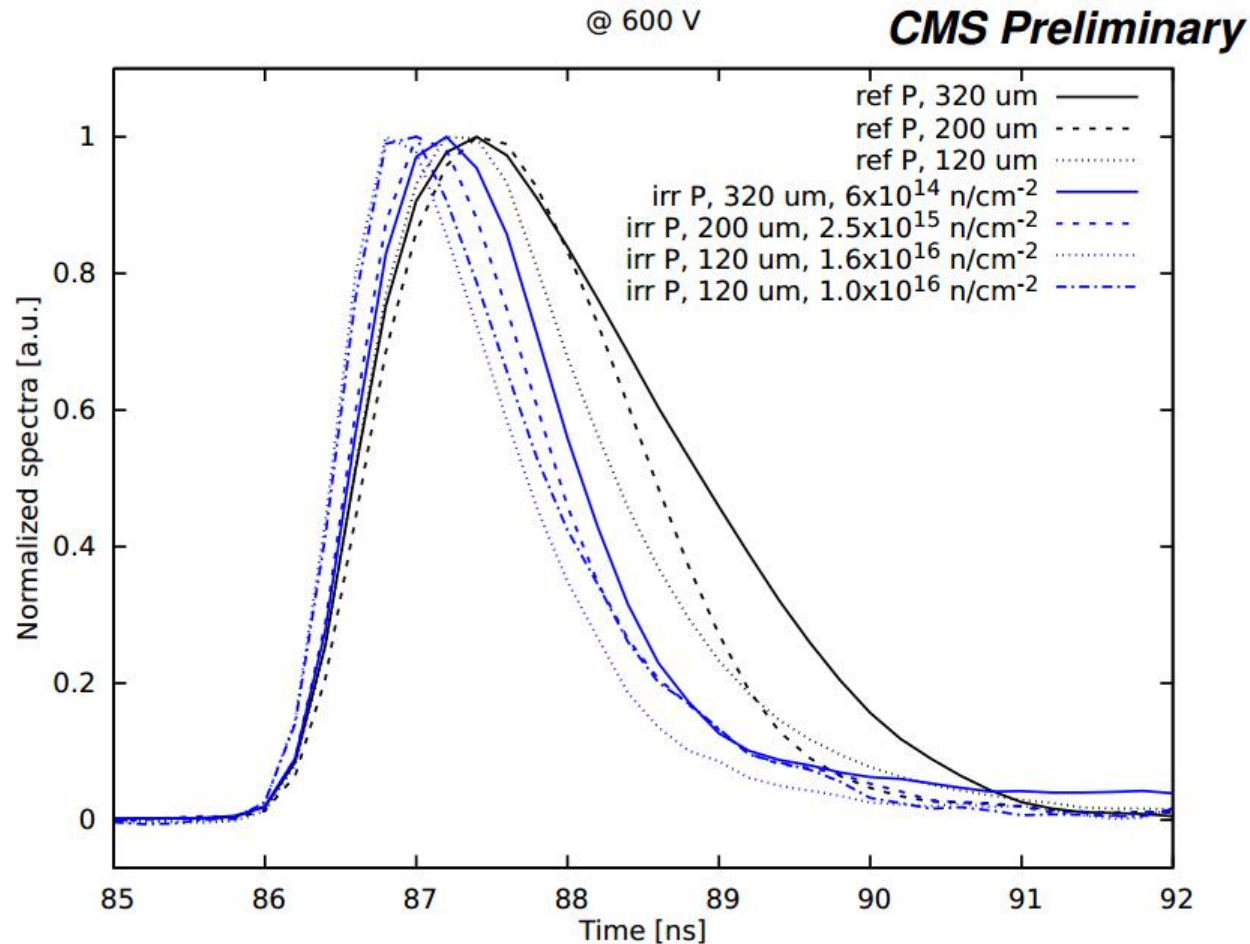
Calibration curve \Rightarrow from -10°C to -40°C



- ✓ measurement of bulk current vs bias voltage (IV) as function of temperature (from -10 to -40°C) for few diodes
- ✓ Results are compatible between p-type and n-type
- ✓ Also compatible between different active thickness

Characterization after neutron irradiation

TCT spectra → 600 V (normalized amplitude)

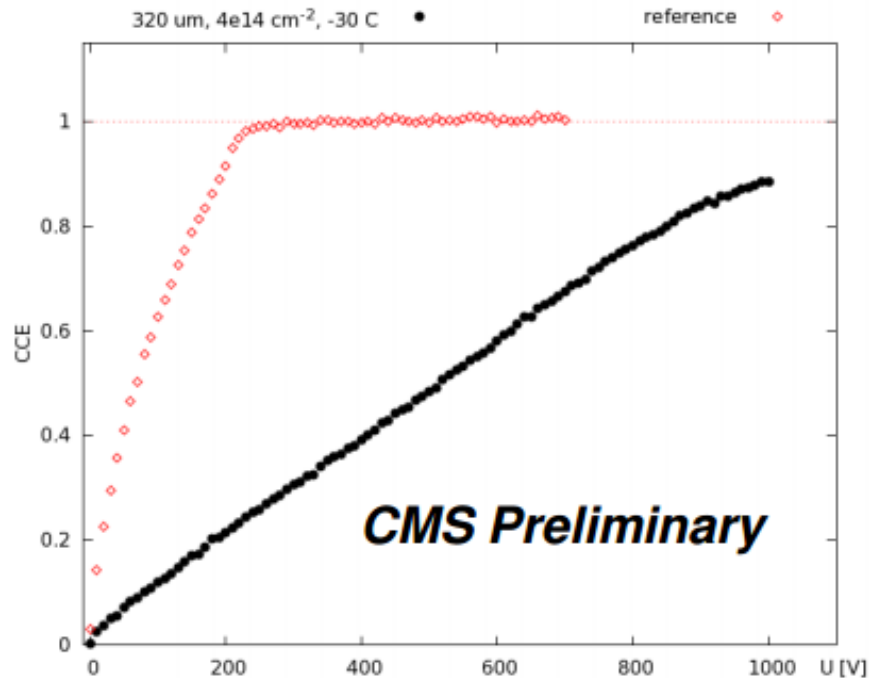


- ✓ IR laser (1060 nm) pulse width: 50 ps
- ✓ TCT pulse width < 10ns
- ✓ Shorter pulse and raise time after irradiation → relevant for timing

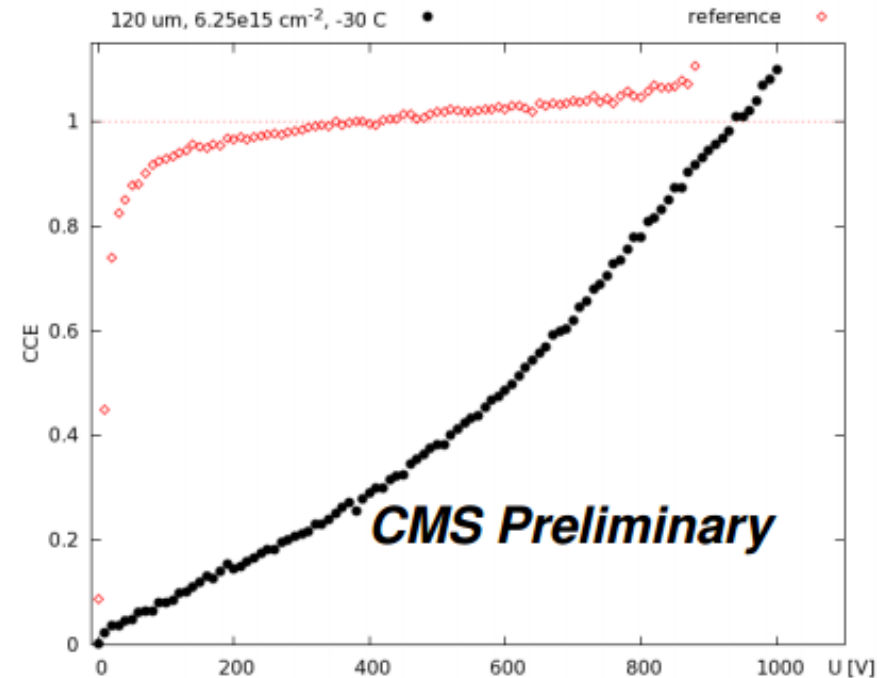
Characterization after neutron irradiation

Charge collection efficiency measurement \Rightarrow TCT IR laser

n-in-p deep diffused float zone



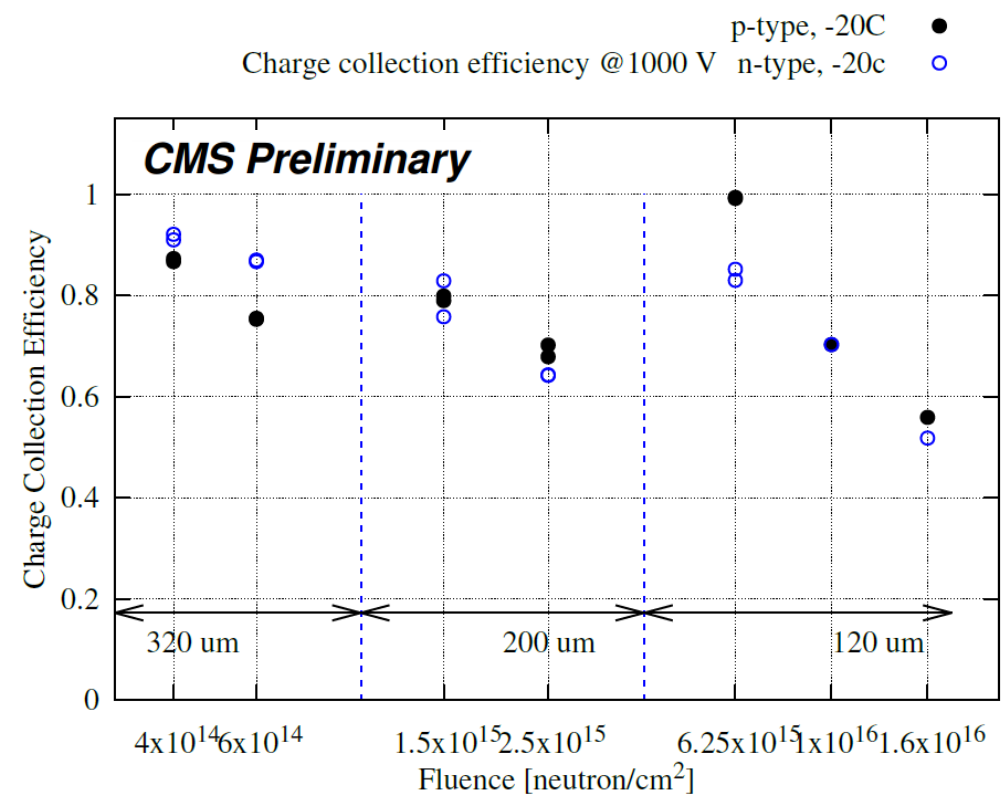
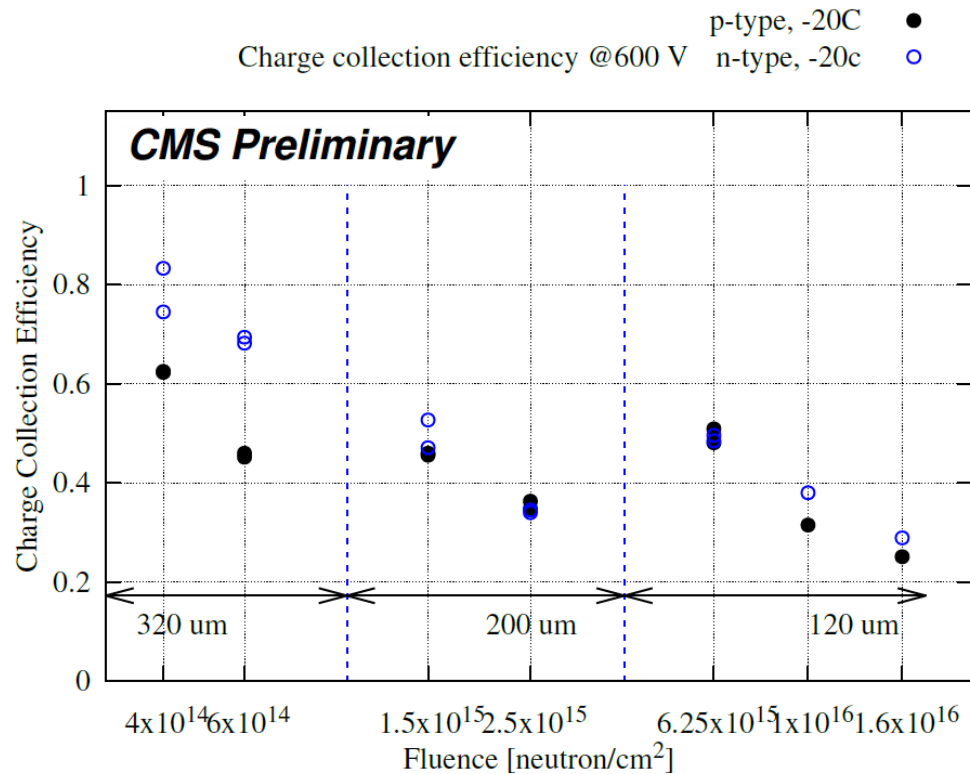
n-in-p deep diffused float zone



- ✓ Measure the charge Q_{ref} for unirradiated diode (reference) integrating spectrum from TCT
- ✓ Q_{ref} is defined for fully depleted diode at $U = 400 \text{ V}$
- ✓ Q = integrated charge for irradiated diode
- ✓ $CCE = Q / Q_{ref}(400V)$

Characterization after neutron irradiation

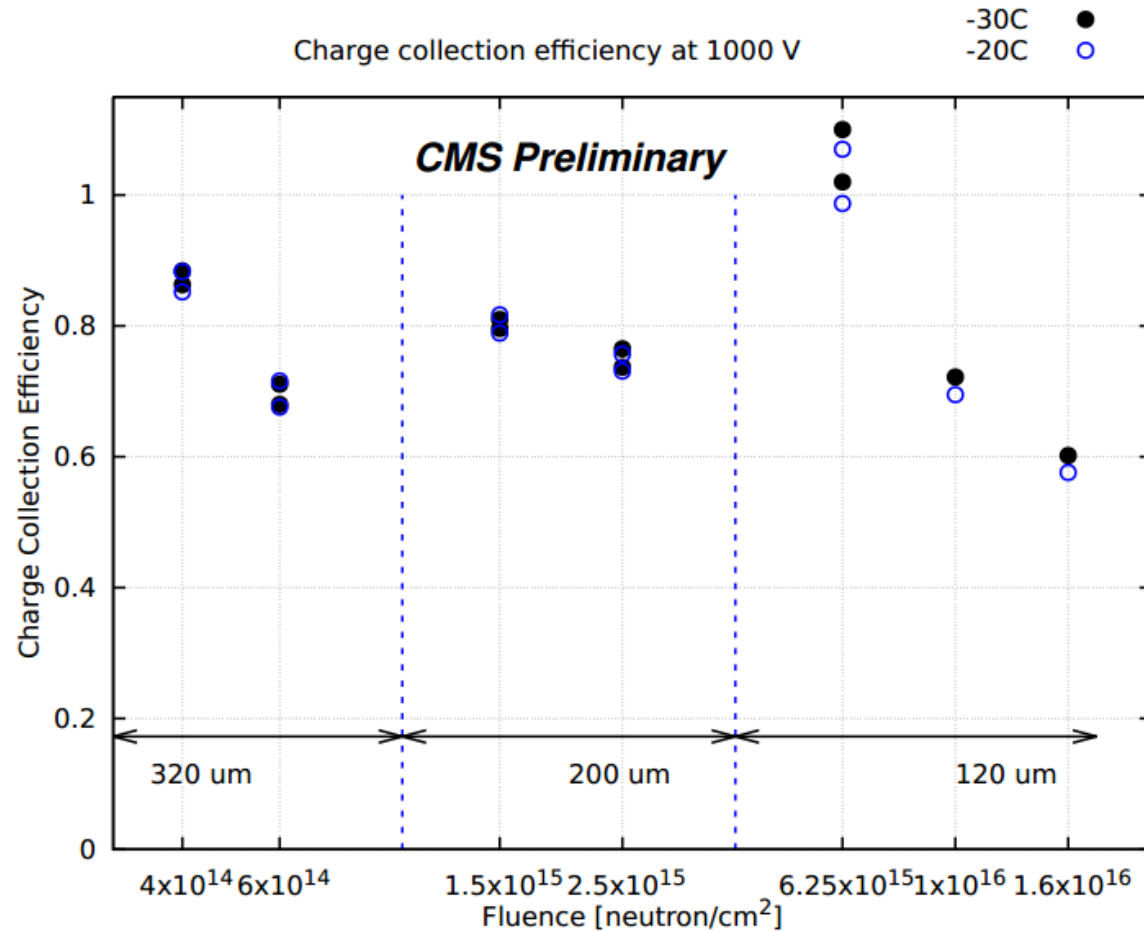
Charge collection efficiency \Rightarrow n-type vs p-type



- ✓ For a low bias voltage CCE for n-type diodes is higher than for the p-type
- ✓ For a higher bias voltage p-type and n-type have similar CCE values.

Characterization after neutron irradiation

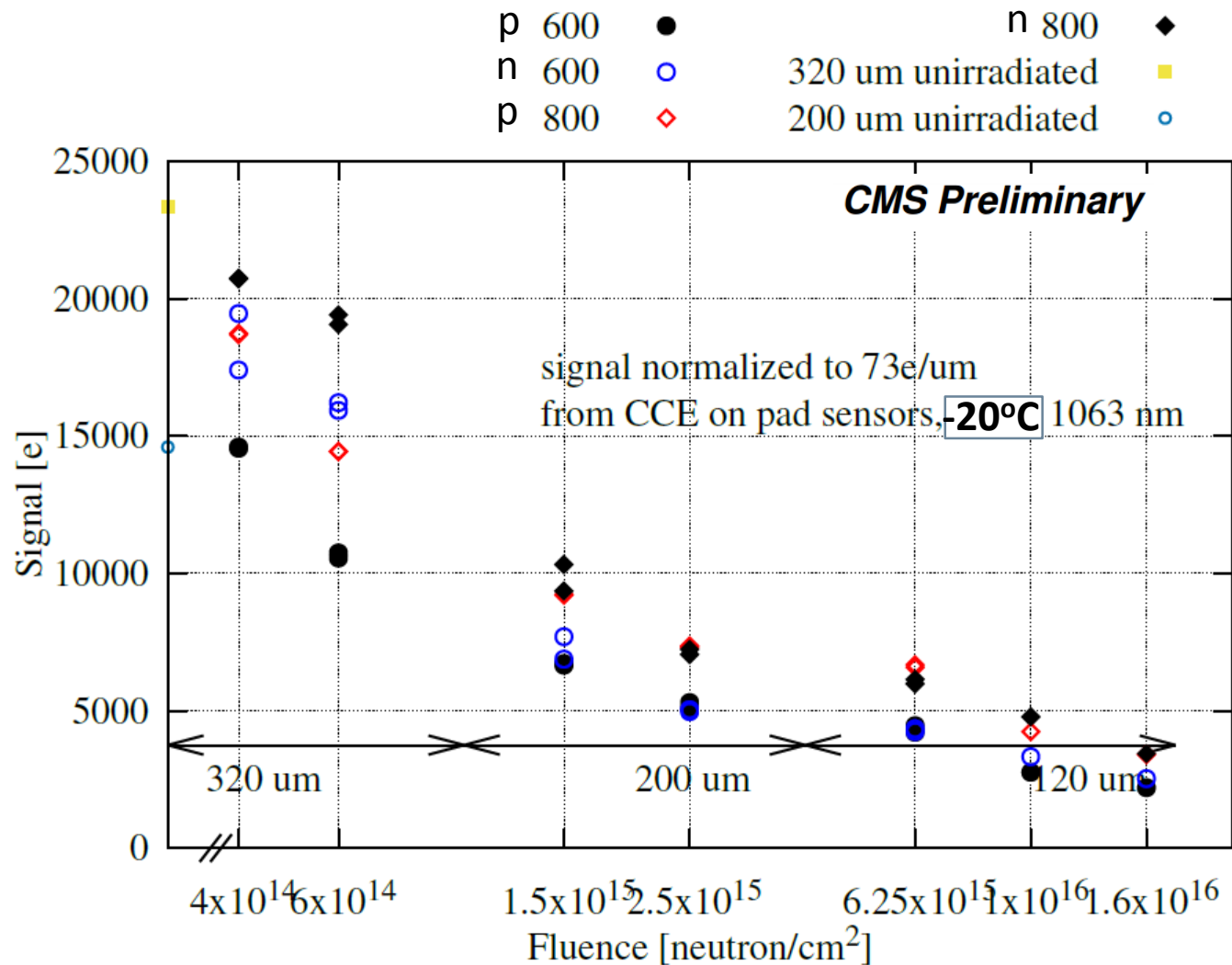
Charge collection efficiency vs temperature \Rightarrow p-type diodes



✓ We have the same result for the CCE at -20°C and -30°C

Characterization after neutron irradiation

Charge collection efficiency \Rightarrow in electrons (21.900 e⁻ for 300um of Si)



Summary and future activities

- ✓ Charge collection efficiency (CCE) measured at -20°C and at -30°C :
 - CCE measurement at -20°C can be used for lower temperatures
- ✓ Signal pulse shorter than 10 ns (from TCT measurement)
- ✓ To do:
 - ✓ perform 80 min at 60°C additional annealing on half of the diodes (two weeks at room temperature) → repeat measurements
 - ✓ Re-irradiation of other half of the sensors (those not annealed) to have estimate for +50% fluence with respect to the nominal one
 - ✓ compare against data of HPK campaign (lower fluence neutrons, but also protons...)
 - ✓ Continue with the measurement at CERN after the annealing and Re-irradiation of the sensors
 - ✓ Measurement with beta source to be performed → for MIP sensitivity

Questions ...

